



## General Description

The SJP015P2600 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -10V. This device is suitable for use as a wide variety of applications.

## Features

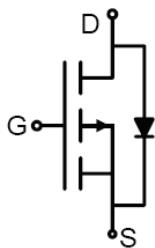
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

## Application

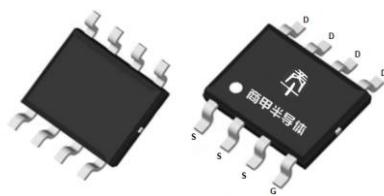
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

## Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	-150	V
$R_{DS(ON)}_{TYP}$	265	mΩ
$I_D$	-2.2	A
$Q_G$	38.6	nC



Schematic Diagram



SOP-8 top&amp;bottom view

## Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Reel Size	Tape width	Quantity
SJP015P2600	P015P2600	SOP-8	\	\	\

Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	-150	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	-2.2	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	-1.4	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-8.8	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	3.6	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	1.4	W
$E_{AS}$	Avalanche energy (Note 2)	72.3	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		34.8	°C/W



## 150V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	-150			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-150\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			-1	$\mu\text{A}$
		$V_{\text{DS}}=-150\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			-100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	-2		-4	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$ , $I_{\text{D}}=-2\text{A}$		10		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-2\text{A}$ $T_J=25^\circ\text{C}$		265	345	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-50\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		2069		pF
$C_{\text{oss}}$	Output Capacitance			44.3		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			37.1		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		5.2		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-50\text{V}$ , $R_{\text{L}}=25\Omega$ , $R_{\text{GEN}}=3\Omega$		30		nS
$t_r$	Turn-on Rise Time			34		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			241		nS
$t_f$	Turn-Off Fall Time			131		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-50\text{V}$ , $I_{\text{D}}=-2\text{A}$		38.6		nC
$Q_{\text{gs}}$	Gate-Source Charge			8.1		nC
$Q_{\text{gd}}$	Gate-Drain Charge			9.4		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				-2.2	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-2\text{A}$			-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{F}}=-2\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$		34		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_{\text{F}}=-2\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$		32.3		nC

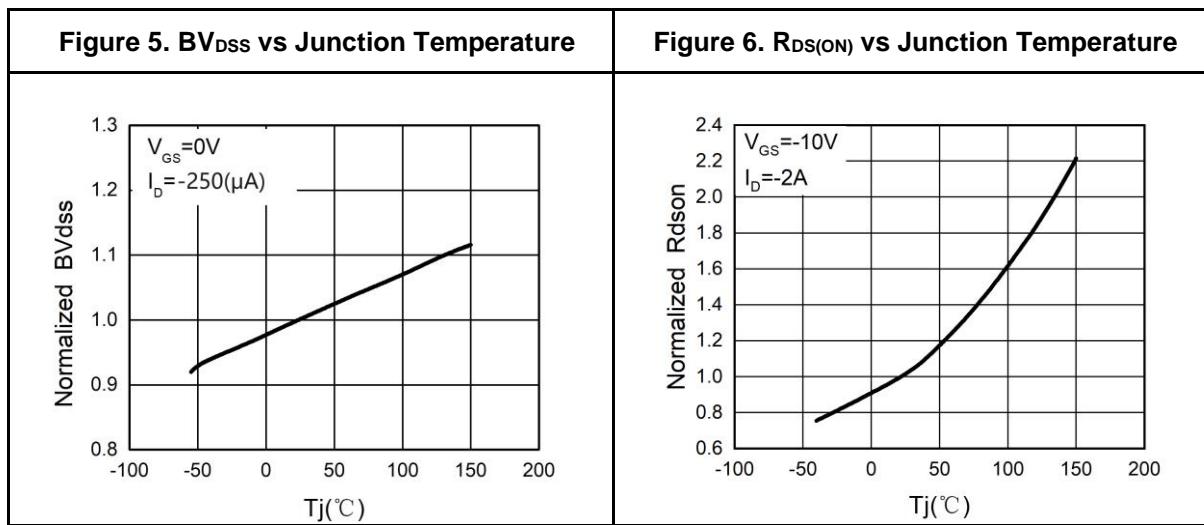
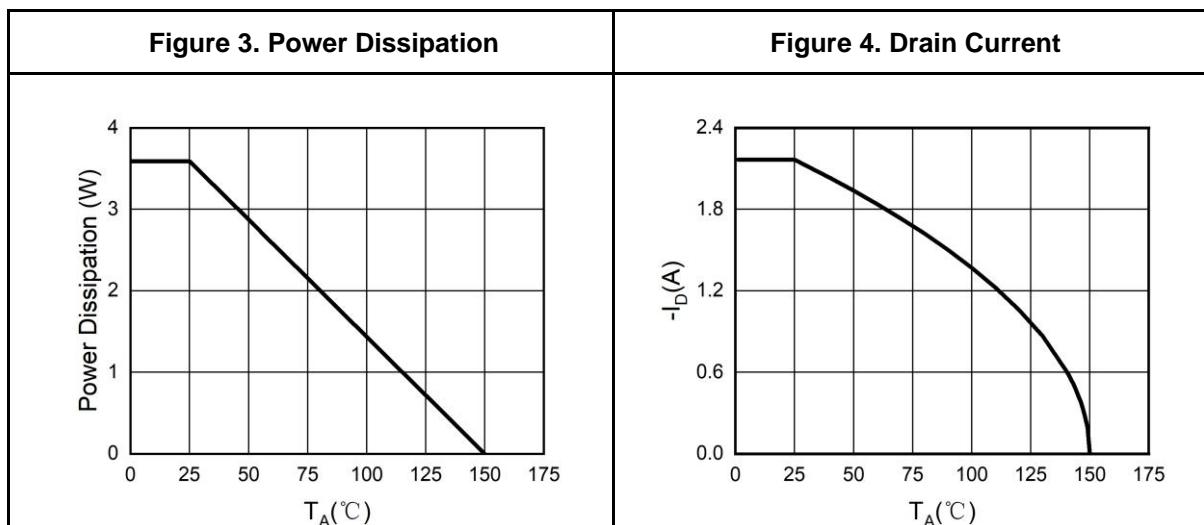
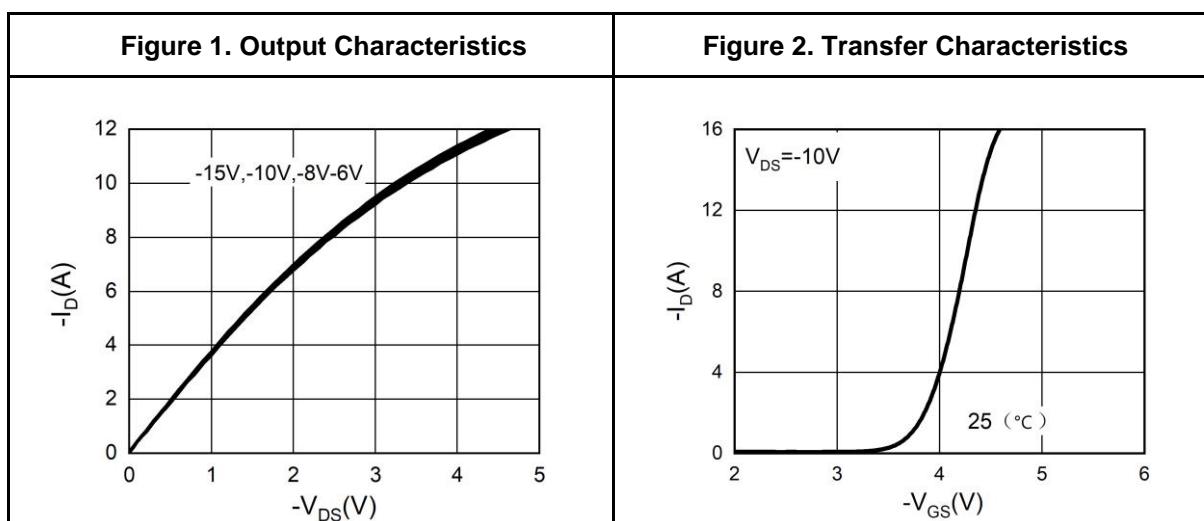
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=-50\text{V}$ ,  $V_{\text{G}}=-10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

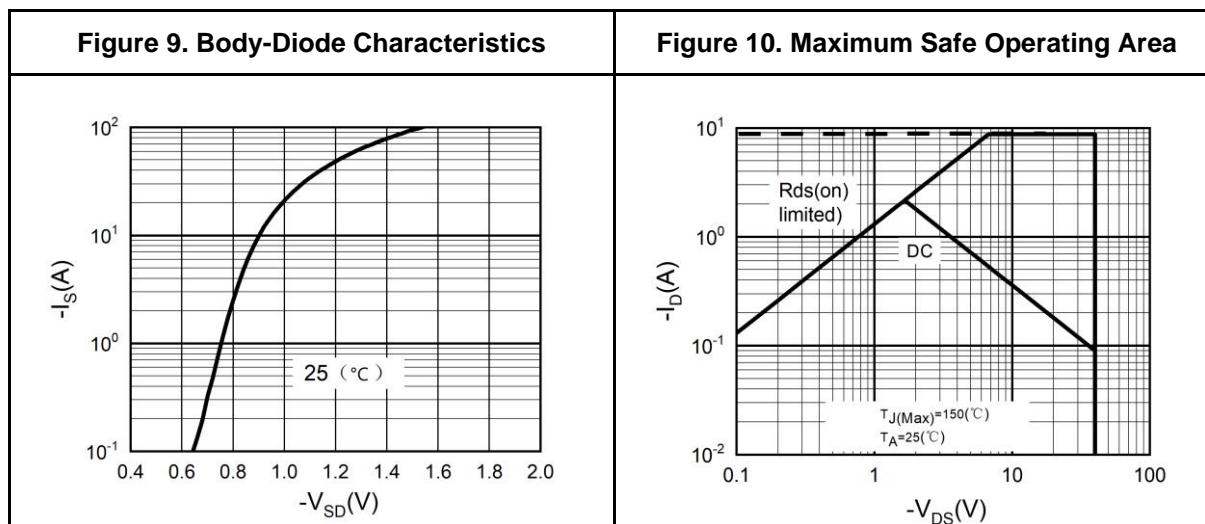
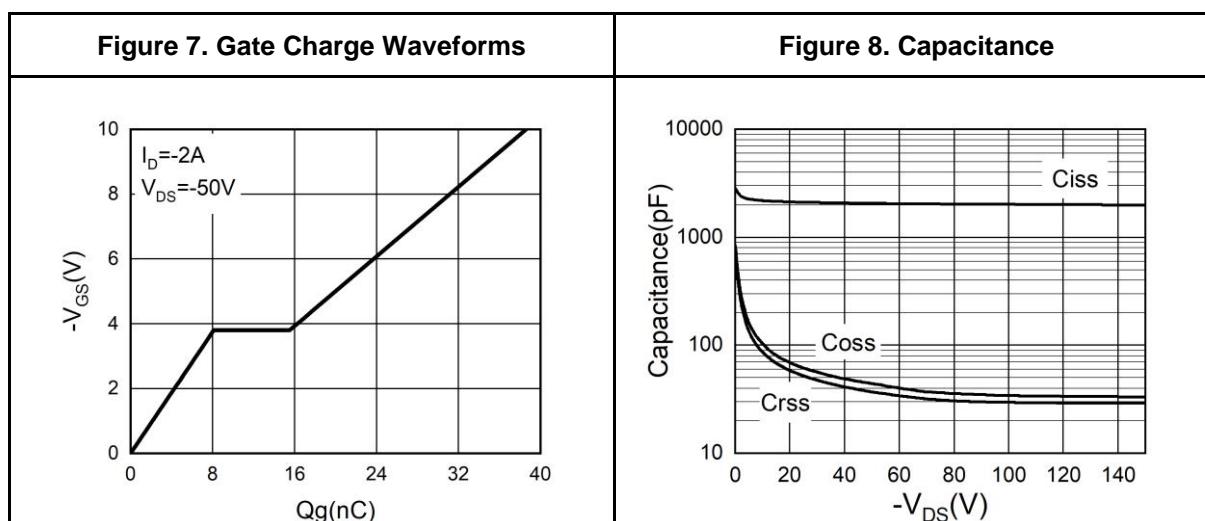


## Typical Electrical And Thermal Characteristics (Curves)



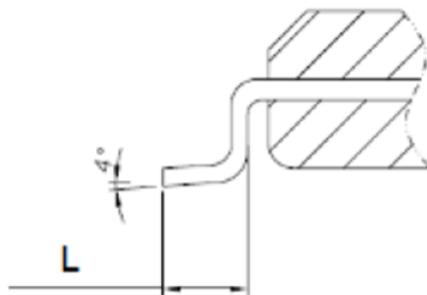
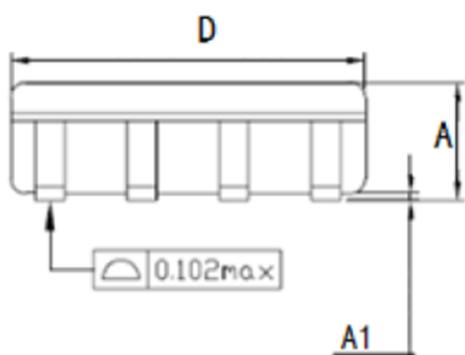
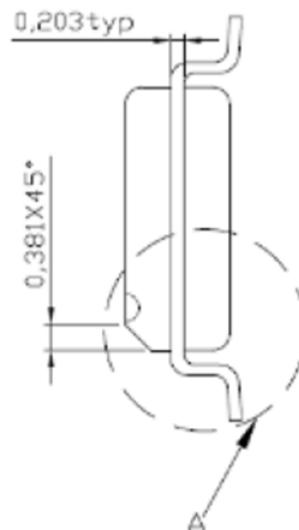
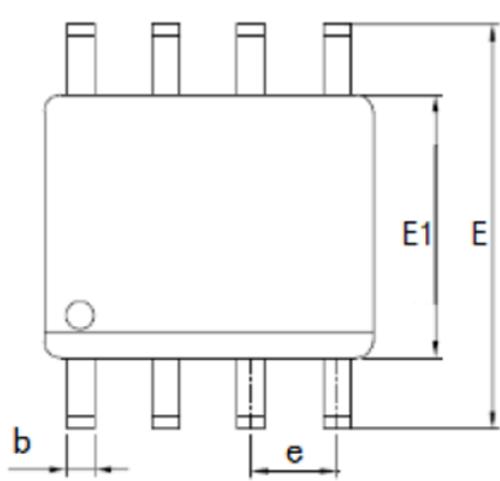


## Typical Electrical And Thermal Characteristics (Curves)





## SOP-8 Package Information



A 局部放大

Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max
A	1.35	1.55	1.75
A1	0.1	0.15	0.2
b	0.346	0.406	0.466
D	4.8	4.89	4.98
E	5.75	6.00	6.25
E1	3.81	3.90	3.99
e		1.27TYP	
L	0.406	0.838	1.27



## **Attention**

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